Count	RefDes	Value	Part Number	Description	MFR
Size	Reference	Second Source			
1	C15	.01U	std	Capacitor, Ceramic, 25V, [temp], [tol]	muRata
603					
1	C17	.47u	std	Capacitor, Ceramic, 10V, [temp], [tol]	muRata
603					
1	C19	100p	std	Capacitor, Ceramic, 25V, [temp], [tol]	muRata
603					
1	C20	1000p	std	Capacitor, Ceramic, 25V, [temp], [tol]	muRata
603					
4	C10	2200P	std	Capacitor, Ceramic, 25V, [temp], [tol]	muRata
603					
	C12				
	C18				
	C22				
1	C16	1u	std	Capacitor, Ceramic, 10V, [temp], [tol]	muRata
805					
2	C11	4.7u	std	Capacitor, Ceramic, 10V, [temp], [tol]	muRata
805					
	C14				
2	C8	3.3U	Std	Capacitor, Ceramic, 50V, [temp], [tol]	Vishay
1210					
	C23				
6	C1	10U	Std	Capacitor, Ceramic, 25V, [temp], [tol]	Vishay
1210					
	C2				
	C5				
	C9				
	C13				

	C21					
2	C6	560u	50ZL560 12.5X20	Capacitor, Aluminum Electrolytic,50V	Rubycon	0.492 inch
	C7					
2	C3	1000u	25ZL1000 12.5X20	Capacitor, Aluminum Electrolytic,25V	Rubycon	0.492 inch
	C4					
2	J1	LUG#2	GSLU-70	Lug, Solderless, #2 - #8 AWG, 1/4", Copper	ILSCO	1.55 x 0.50 inch
	J2					
1	D1	BAS21	BAS21	Diode, Switching, 200-mA, 200-V, 330-mW	Zetex	SOT23
1	D2	OPEN	BAS21	Diode, Switching, 200-mA, 200-V, 330-mW	Zetex	SOT23
2	D3	48CTQ060S	STD	Diode, Dual Schottky, 48A,60-V	STD	D2PAK
	D6					
1	D5	6.8v	MMBZ5235BLT1	Diode, Zener, 6.8-V, yy-mA, zz-mW, q%	Motorola	SOT23
1	D4	10v	MMBZ5240BLT1	Diode, Zener, 10-V, yy-mA, zz-mW, q%	Motorola	SOT23
4	L2	3.3U	IHLP5050FDER3R3M	Inductor, SMT, yyA, zzmilliohm	VISHEY	0.51 x 0.51 inch
	L3					
	L4					
	L5					
1	L1	short	IHLP5050FDERR47M	Inductor, SMT, yyA, zzmilliohm	{MFR}	

0.51 x 0.51 inc

h

1	R13	2K	Std	Resistor, Chip, 1/16W, yy%	Std
603					
1	R5	2k	Std	Resistor, Chip, 1/16-W, yy%	Std
603					
1	R12	2.49k	Std	Resistor, Chip, 1/16-W, yy%	Std
603					
1	R17	6.19K	Std	Resistor, Chip, 1/16W, yy%	Std
603					
1	R4	7.5k	Std	Resistor, Chip, 1/16-W, yy%	Std
603					
1	R11	8.66k	Std	Resistor, Chip, 1/16-W, yy%	Std
603					
1	R18	10	Std	Resistor, Chip, 1/16W, yy%	Std
603					
1	R19	10K	Std	Resistor, Chip, 1/16W, yy%	Std
603					
1	R9	10k	Std	Resistor, Chip, 1/16-W, yy%	Std
603					
1	R3	16.2k	Std	Resistor, Chip, 1/16-W, yy%	Std
603					
1	R25	20k	Std	Resistor, Chip, 1/16W, yy%	Std
603					
1	R26	49.9	Std	Resistor, Chip, 1/16W, yy%	Std
603					
2	R21	49.9K	Std	Resistor, Chip, 1/16W, yy%	Std
603					
	R27				
1	R22	93.1k	Std	Resistor, Chip, 1/16W, yy%	Std
603					
1	R10	133k	Std	Resistor, Chip, 1/16-W, yy%	Std
603					
4	R6	200	Std	Resistor, Chip, 1/16W, yy%	Std
603					
	R14				
	R20				
	R29				
1	R28	806	Std	Resistor, Chip, 1/16W, yy%	Std
603					
2	R1	4.99k	Std	Resistor, Chip,	

					1/10W, yy%	Std
805						
	R2					
8	R7	.01	Std		Resistor, Chip, 1/8W, yy%	Std
1206						
	R8					
	R15					
	R16					
	R23					
	R24					
	R30					
	R31					
1	J4	ED1514	ED1514		Terminal Block, 2-pin, 6-A, 3.5mm	OST
0.27 x 0.25 inch		\\vette02\pmp_pcb\pcad_pdf's\ED1524.pdf	C:\program files\p-cad 2004\pcad_pdf's\ED1524.pdf			
1	J3	{value}	ED1981		Terminal Block, 2-pin, 32-A, 9.5mm	OST
0.75 x 0.49 inch		\\vette02\pmp_pcb\pcad_pdf's\ED1981.pdf	C:\program files\p-cad 2004\pcad_pdf's\ED1981.pdf			
1	U2	TL431ADBZ	TL431ADBZ		IC, Precision Adjustable Shunt Regulator	TI
SOT23-3						
1	U1	TLC372CD	TLV372xD		IC, Dual Comparator, 200-ns	TI
SO8						
13	TP1	5000	5000		Test Point, Red, Thru Hole Color Keyed	Keystone

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TP5

	TP8						
1	U4	TPS40090PW	TPS40090PW	IC, High-Frequency, Multiphase Controller	TI	TSSOP24	
1	Q4	2N7002	2N7002DICT	MOSFET, N-ch, 60-V, 115-mA, 1.2-Ohms	Vishay-Liteon	SOT23	
4	Q2	CSD18534Q5A	CSD17510Q5A	MOSFET, N-Chan, 60V, 80A, 12 milliohm	TI	QFN-8 POWER	\\vette02\pmp_pcb\pcad_pdf's\CSD17510Q5A.pdf C:\program files\p-cad 2004\pcad_pdf's\CSD17510Q5A.pdf
	Q3						
	Q5						
	Q6						
1	Q1	PTZ2222A	STD	Bipolar, NPN, xx-V, yy-mA, zz-W	STD	SOT223	
2	U3	UCC27324D	UCC27324D	IC, High Speed Low Side Power MOSFET driver	Texas Instruments	SO8	
	U5						

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